查询74FCT162841CTPACT供应商 Data sheet acquired from Cypress Semiconductor Corporation. Data sheet modified to remove devices not offered.



# CY74FCT16841T CY74FCT162841T

20-Bit Latches

SCCS067 - July 1994 - Revised March 2000

#### Features

- FCT-C speed at 5.5 ns (FCT16841T Com'l)
- Power-off disable outputs permits live insertion
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps</li>
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of –40°C to +85°C
- V<sub>CC</sub> = 5V ± 10%

#### CY74FCT16841T Features:

- 64 mA sink current, 32 mA source current
- Typical V<sub>OLP</sub> (ground bounce) <1.0V at V<sub>CC</sub> = 5V,  $T_A = 25^{\circ}C$

CY74FCT162841T Features:

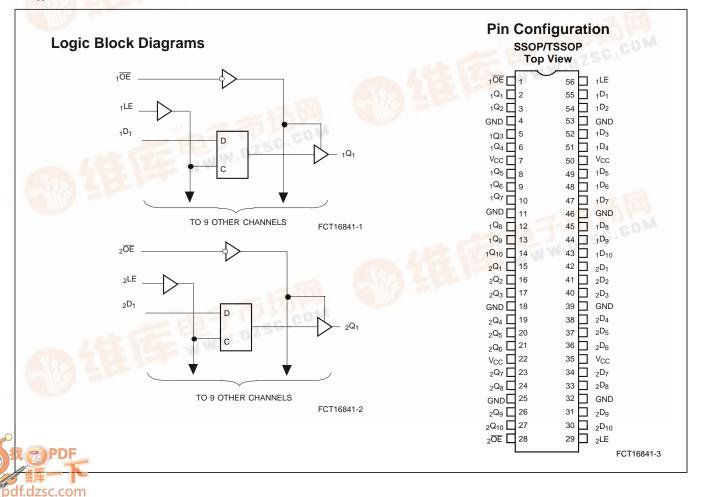
- Balanced 24 mA output drivers
- Reduced system switching noise
- Typical V<sub>OLP</sub> (ground bounce) <0.6V at V<sub>CC</sub> = 5V, T<sub>A</sub>= 25°C

#### **Functional Description**

The CY74FCT16841T and CY74FCT162841T are 20-bit D-type latches designed for use in bus applications requiring high speed and low power. These devices can be used as two independent 10-bit latches, or as a single 10-bit latch, or as a single 20-bit latch by connecting the Output Enable (OE) and Latch (LE) inputs. Flow-through pinout and small shrink packaging aid in simplifying board layout. The output buffers are designed with a power-off disable feature to allow live insertion of boards.

The CY74FCT16841T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162841T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162841T is ideal for driving transmission lines.





## **Pin Description**

Name	Description
D	Data Inputs
LE	Latch Enable Input (Active HIGH)
ŌĒ	Output Enable Input (Active LOW)
0	Three-State Outputs

# Maximum Ratings<sup>[3, 4]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–55°C to +125°C
Ambient Temperature with Power Applied	–55°C to +125°C
DC Input Voltage	–0.5V to +7.0V
DC Output Voltage	–0.5V to +7.0V
DC Output Current (Maximum Sink Current/Pin)	60 to +120 mA

#### Electrical Characteristics Over the Operating Range

	Inputs	Outputs	
D	LE	OE	Q
Н	Н	L	Н
L	Н	L	L
Х	L	L	Q <sup>[2]</sup>
Х	Х	Н	Z

Power Dissipation	1.0W
Static Discharge Voltage	>2001V
(per MIL-STD-883, Method 3015)	

#### **Operating Range**

Range	Ambient Range Temperature	
Industrial	–40°C to +85°C	$5V \pm 10\%$

Parameter	Description	Test Conditions	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
V <sub>IH</sub>	Input HIGH Voltage	Logic HIGH Level	2.0			V
V <sub>IL</sub>	Input LOW Voltage	Logic LOW Level			0.8	V
V <sub>H</sub>	Input Hysteresis <sup>[6]</sup>			100		mV
V <sub>IK</sub>	Input Clamp Diode Voltage	V <sub>CC</sub> =Min., I <sub>IN</sub> =-18 mA		-0.7	-1.2	V
I <sub>IH</sub>	Input HIGH Current	V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>CC</sub>			±1	μA
IIL	Input LOW Current	V <sub>CC</sub> =Max., V <sub>I</sub> =GND			±1	μA
I <sub>OZH</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.7V			±1	μA
I <sub>OZL</sub>	High Impedance Output Current (Three-State Output pins)	V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.5V			±1	μA
I <sub>OS</sub>	Short Circuit Current <sup>[7]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND	-80	-140	-200	mA
I <sub>O</sub>	Output Drive Current <sup>[7]</sup>	V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.5V	-50		-180	mA
I <sub>OFF</sub>	Power-Off Disable	V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.5V <sup>[8]</sup>			±1	μA

Notes:

1.

8. Tested at +25°C.

<sup>2.</sup> 3.

H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = HIGH Impedance. Output level before LE HIGH-to-LOW Transition. Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range. Unused inputs must always be connected to an appropriate logic voltage level, preferably either  $V_{CC}$  or ground.

<sup>4.</sup> 

Typical values are at  $V_{CC}$ = 5.0V,  $T_{A}$ = +25°C ambient. 5.

This parameter is specified but not tested. 6. 7.

Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, los tests should be performed last.



## **Output Drive Characteristics for CY74FCT16841T**

Parameter	Description	Test Conditions	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =–3 mA	2.5	3.5		V
		V <sub>CC</sub> =Min., I <sub>OH</sub> =–15 mA	2.4	3.5		
		V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA	2.0	3.0		
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA		0.2	0.55	V

#### **Output Drive Characteristics for CY74FCT162841T**

Parameter	Description	Test Conditions	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
I <sub>ODL</sub>	Output LOW Current <sup>[7]</sup>	$V_{CC}$ =5V, $V_{IN}$ =V <sub>IH</sub> or $V_{IL}$ , $V_{OUT}$ =1.5V	60	115	150	mA
I <sub>ODH</sub>	Output HIGH Current <sup>[7]</sup>	$V_{CC}$ =5V, $V_{IN}$ =V <sub>IH</sub> or $V_{IL}$ , $V_{OUT}$ =1.5V	-60	–115	-150	mA
V <sub>OH</sub>	Output HIGH Voltage	V <sub>CC</sub> =Min., I <sub>OH</sub> =-24 mA	2.4	3.3		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> =Min., I <sub>OL</sub> =24 mA		0.3	0.55	V

# **Capacitance**<sup>[6]</sup> (T<sub>A</sub> =+25°C, f = 1.0 MHz)

Symbol	Description	Conditions	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$V_{IN} = 0V$	4.5	6.0	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>OUT</sub> = 0V	5.5	8.0	pF

## **Power Supply Characteristics**

Parameter	Description	Test Condit	ions	Min.	<b>Typ.</b> <sup>[5]</sup>	Max.	Unit
I <sub>CC</sub>	Quiescent Power Supply Current	V <sub>CC</sub> =Max.	V <sub>IN</sub> ≤0.2V V <sub>IN</sub> ≥V <sub>CC</sub> -0.2V	_	5	500	μA
Δl <sub>CC</sub>	Quiescent Power Supply Current (TTL inputs HIGH)	V <sub>CC</sub> =Max.,	V <sub>IN</sub> =3.4V <sup>[9]</sup>	_	0.5	1.5	mA
I <sub>CCD</sub>	Dynamic Power Supply Current <sup>[10]</sup>	V <sub>CC</sub> =Max., One Input Toggling, 50% Duty Cycle, Outputs Open, OE=GND	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND		60	100	μA/MHz
I <sub>C</sub>	Total Power Supply Current <sup>[11]</sup>	50% Duty Cycle,	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	—	0.6	1.5	mA
		Outputs Open, One Bit Toggling, OE=GND LE = V <sub>CC</sub>	V <sub>IN</sub> =3.4V or V <sub>IN</sub> =GND	—	0.9	2.3	
		V <sub>CC</sub> =Max., f <sub>1</sub> =2.5 MHz, 50% Duty Cycle, Outputs	V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND	_	3.0	5.5 <sup>[12]</sup>	
		Open, Tw <u>ent</u> y Bits Toggling, OE=GND LE = V <sub>CC</sub>	V <sub>IN</sub> =3.4V or V <sub>IN</sub> =GND	—	8.0	20.5 <sup>[12]</sup>	

#### Notes:

- Notes:9. Per TTL driven input ( $V_{IN}$ =3.4V); all other inputs at  $V_{CC}$  or GND.10. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.11.  $I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC}$  $I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_0/2 + f_1 N_1)$  $I_{CC} = Quiescent Current with CMOS input levels$  $\Delta I_{CC} = Power Supply Current for a TTL HIGH input (<math>V_{IN}$ =3.4V) $D_H = Duty Cycle for TTL inputs HIGH$  $N_T = Number of TTL inputs at D_H$  $I_{CCD} = Dynamic Current caused by an input transition pair (HLH or LHL)<math>f_0 = Clock$  frequency for registered devices, otherwise zero $f_1 = Input signal frequency$  $N_1 = Number of inputs changing at f_1$ All currents are in milliamps and all frequencies are in megahertz.12. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not test

12. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not tested.



# Switching Characteristics Over the Operating Range<sup>[13]</sup>

			74FCT1	6841AT	74FCT10 74FCT16			Fig
Parameter	Description	Condition <sup>[14]</sup>	Min.	Max.	Min.	Max.	Unit	Fig. No. <sup>[15]</sup>
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay D to Q	C <sub>L</sub> =50 pF R <sub>L</sub> =500Ω	1.5	9.0	1.5	5.5	ns	1, 5
	(LE=HIGH)	$C_L=300 \text{ pF}^{[16]}$ $R_L=500\Omega$	1.5	13.0	1.5	13.0		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay LE to Q	C <sub>L</sub> =50 pF R <sub>L</sub> =500Ω	1.5	12.0	1.5	6.4	ns	1, 5
		C <sub>L</sub> =300 pF <sup>[16]</sup> R <sub>L</sub> =500Ω	1.5	16.0	1.5	15.0		
t <sub>PHZ</sub> t <sub>PZL</sub>	Output Enable Time OE to Q	C <sub>L</sub> =50 pF R <sub>L</sub> =500Ω	1.5	11.5	1.5	6.5	ns	1, 7, 8
		$C_L=300 \text{ pF}^{[16]} R_L=500\Omega$	1.5	23.0	1.5	12.0		
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time OE to Q	C <sub>L</sub> =5 pF <sup>[16]</sup> R <sub>L</sub> =500Ω	1.5	7.0	1.5	5.7	ns	1, 7, 8
		C <sub>L</sub> =50 pF R <sub>L</sub> =500Ω	1.5	8.0	1.5	6.0		
t <sub>SU</sub>	Set-Up Time HIGH or LOW, D to LE	C <sub>L</sub> =50 pF R <sub>L</sub> =500Ω	2.5	—	2.0	—	ns	9
t <sub>H</sub>	Hold Time HIGH or LOW, D to LE		2.5	_	1.5	—	ns	9
t <sub>W</sub>	LE Pulse Width HIGH	]	4.0 <sup>[17]</sup>		4.0 <sup>[17]</sup>	—	ns	5
t <sub>SK(O)</sub>	Output Skew <sup>[18]</sup>	]	—	0.5	—	0.5	ns	—

Notes:

Minimum limits are specified but not tested on Propagation Delays.
See test circuit and waveform.
See "Parameter Measurement Information" in the General Information section.
These conditions are specified but not tested.
These limits are specified but not tested.
Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.

# Ordering Information for CY74FCT16841T

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
5.5	CY74FCT16841CTPVC/PVCT	O56	56-Lead (300-Mil) SSOP	Industrial
6.5	CY74FCT16841ATPVC/PVCT	O56	56-Lead (300-Mil) SSOP	Industrial

## Ordering Information CY74FCT162841T

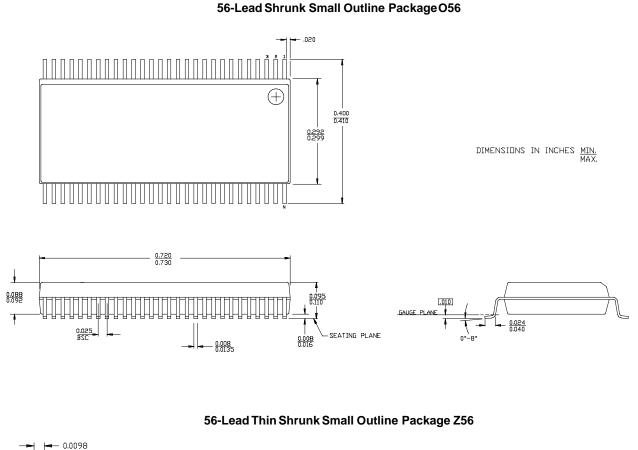
Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
5.5	74FCT162841CTPACT	Z56	56-Lead (240-Mil) TSSOP	Industrial
	CY74FCT162841CTPVC	O56	56-Lead (300-Mil) SSOP	
	74FCT162841CTPVCT	O56	56-Lead (300-Mil) SSOP	

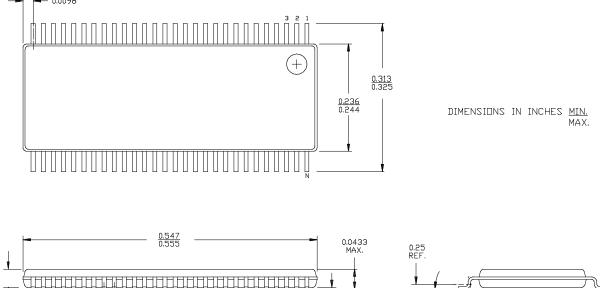


# **Package Diagrams**

0.0335 0.0374

0.0197 BSC





0.002

-SEATING PLANE

0.0067 0.011 <u>0.020</u> 0.030

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